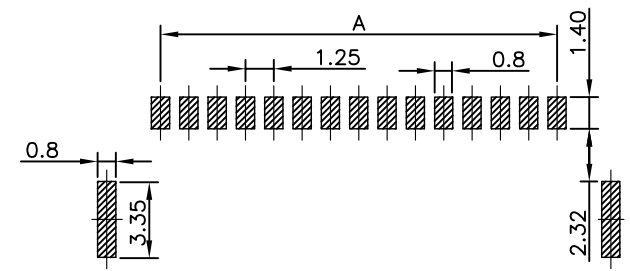
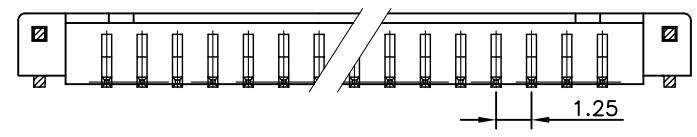
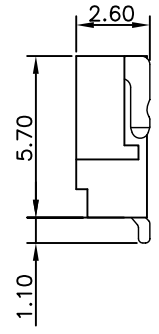
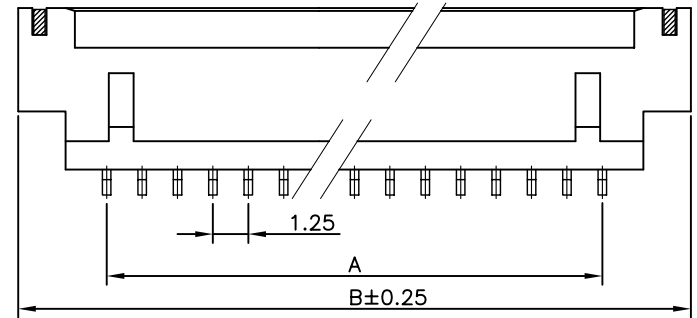
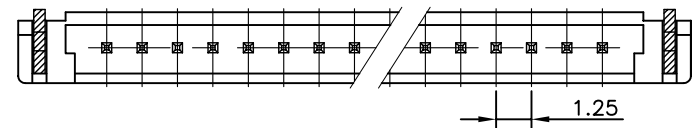


REV.	SPECIFICATION	ECN NO.	APPD.



P.C.Board Layout

Material:

Housing: High Temperature Plastic UL94V-0.

Contacts: Copper Alloy.

Solder Pad: Copper Alloy.

Electrical Characteristics:

Current Rating: 1A AC/DC

Voltage Rating: 100V AC/ max.

Dielectric Withstanding Voltage: 500V AC/ min.

Insulation Resistance: 500MΩ min.at DC 500V

Contact Resistance: 30mΩmax.

Operating Temp: -25°C~+85°C

***RoHS Compliant**

4575- Series 1 X xx T DN1 T

Single Row No. of pin Per Row T: Tin Plated SMD Sid Entry (Right Angle) W/O Post T:Tape & Reel Package U:Tube Package

Position	Dimension	
	A	B
20	23.75	30.00
25	30.00	36.25
30	36.25	42.50

Tolerances	Drawn No.	4575D02001	Title:	
x = ±0.5	Projection		4575 Series	
.x = ±0.25	Unit	mm	Scale	1:1
.xx = ±0.15	Drawn By	SHI 05/24'11	Wire-to-Board 1.25mm	

①704

OUPIIN ELECTRONIC(KUNSHAN) CO., LTD.			
P/N: 4575-1XxxTDN1T			
SHEET	1/1	Ver.No.	A3